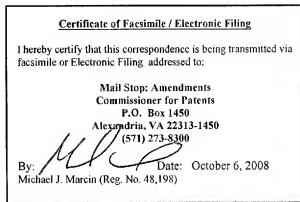


IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : Dusberg et al.
Serial No. : 10/573,862
Filed : October 24, 2006
For : Heat-Conducting Packaging of Electronic Circuit Units
Group Art Unit : 2815
Confirmation No. : 7026
Examiner : Chris C. Chu

Mail Stop: Amendments
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

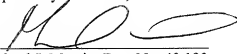


TRANSMITTAL

Transmitted herewith please find a Response to the Non-Final Office Action mailed on July 10, 2008, an executed Power of Attorney, a Statement under 37 CFR 3.73(b) and a Change of Correspondence Address for filing in the above-identified application. No fees are believed to be required. However, the Commissioner is hereby authorized to charge any additional fees to the Deposit Account of **Fay Kaplun & Marcin, LLP No. 50-1492**. A copy of this paper is enclosed for that purpose.

Respectfully submitted,

Dated: October 6, 2008

By: 
Michael J. Marcin, Reg. No. 48,198

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